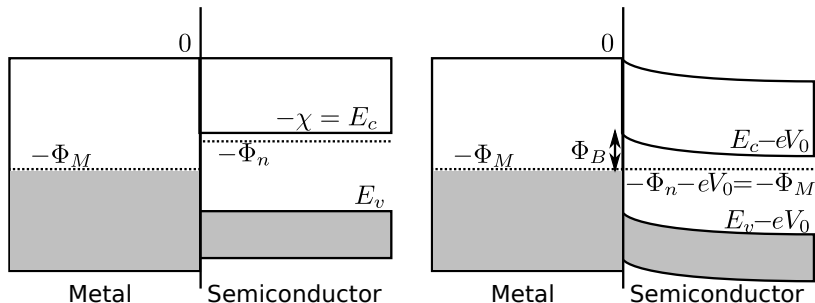


Metal-semiconductor junctions: Schottky diodes and Ohmic contacts

Reading:

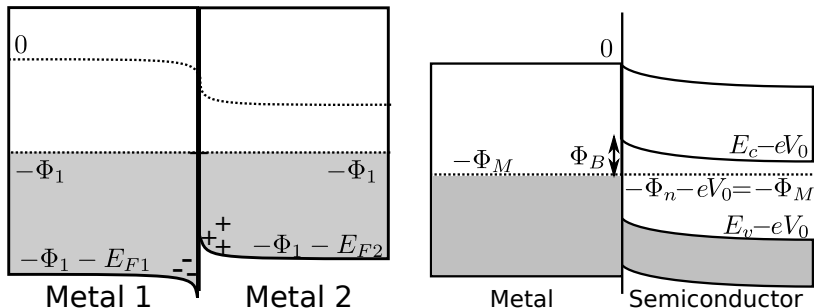
- ▶ Kasap 5.9 - 5.10

Metal-semiconductor contact potential



- ▶ Fermi levels relative to vacuum (Φ) not in same position
- ▶ Distinction for semiconductor: $\Phi \neq$ work function
- ▶ Consider case when metal level below n -type semiconductor
- ▶ Fermi levels line up for equilibrium
- ▶ Electron transfer to metal in current example
- ▶ Schottky barrier height $\Phi_B = \Phi_M - \chi$
- ▶ Contact potential: $V_0 = \Phi_M - \Phi_n$

Depletion region



- ▶ Region of semiconductor near interface where charge transfer occurs
- ▶ Number of charge carriers reduce, hence depletion region
- ▶ In metal-metal case, bands on both sides respond
- ▶ In metal-semiconductor case, only semiconductor responds: why?

Debye screening

- ▶ Poisson equation for variation of electrostatic potential:

$$\nabla^2 \phi(\vec{r}) = -\frac{\rho(\vec{r})}{\epsilon_0}$$

- ▶ Charge density $\rho(\vec{r})$ includes external and bound charge
- ▶ Previously considered bound charge due to \vec{P} response to $\vec{E} = \nabla\phi$
- ▶ What if material responds directly to potential as $\rho = \rho(\phi)$?
- ▶ Specifically consider small change from neutral potential ϕ_0 ,

$$\rho(\vec{r}) \approx \rho'(\phi_0) (\phi(\vec{r}) - \phi_0)$$

- ▶ Poisson equation becomes (using ϵ to account for dipolar response):

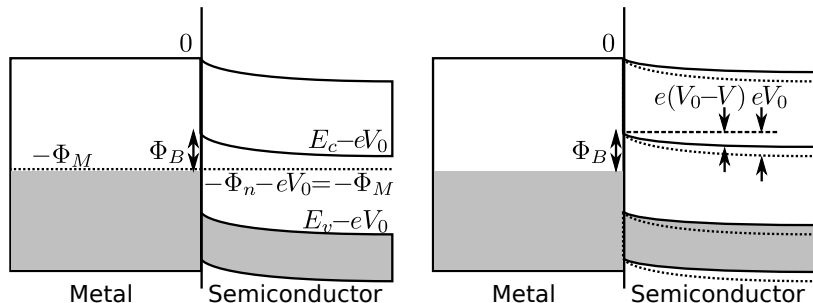
$$\nabla^2(\phi - \phi_0) + \frac{\rho'(\phi_0)}{\epsilon}(\phi - \phi_0) = 0$$

with 1D solutions of the form $\phi(x) = \phi_0 + e^{\pm x/\lambda_D}$
 where $\lambda_D = \sqrt{\epsilon/\rho'(\phi_0)}$ is the Debye screening length

Debye screening length

- ▶ $\lambda_D = \sqrt{\epsilon/\rho'(\phi_0)}$: length scale over which potential restores to neutral
- ▶ Depletion region non-neutral \rightarrow becomes neutral over λ_D length scale
- ▶ Therefore width of depletion region $\sim \lambda_D$
- ▶ In metals, $\rho'(\phi_0) = e^2 g(E_F)$
- ▶ Typical $\lambda_D \sim \sqrt{\frac{8.85 \times 10^{-12} \text{ F/m}}{(1.6 \times 10^{-19} \text{ C})^2 \cdot 10^{47} \text{ J}^{-1} \text{ m}^{-3}}} \sim 0.6 \text{ \AA}$
- ▶ Metals restore potential within an atomic layer!
- ▶ In semiconductors, $\rho'(\phi_0) = e^2 n_{\text{maj}}/(k_B T)$, where $n_{\text{maj}} \approx N_{a/d} =$ majority carrier density (larger of n, p)
- ▶ For $10^{14}/\text{cm}^3$ doped Si at room temperature, $\lambda_D \sim 400 \text{ nm}$
- ▶ For $10^{18}/\text{cm}^3$ doped Si at room temperature, $\lambda_D \sim 4 \text{ nm}$
- ▶ In all cases, $\lambda_D \propto n^{-1/2}$, where $n =$ free carrier density
- ▶ λ_D in metals \ll in semiconductors \Rightarrow depletion region entirely in semiconductor!

Applied bias



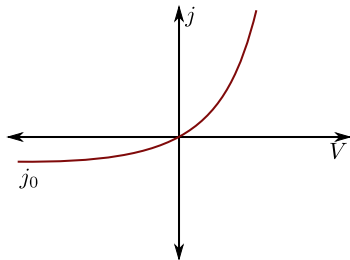
- ▶ Neutral case: band bending in semiconductor = contact potential V_0
- ▶ Apply potential bias: change band bending in semiconductor
- ▶ Forward bias \equiv reduce band bending to $V_0 - V$
- ▶ Rate of electrons $M \rightarrow SC \propto \exp \frac{-\phi_B}{k_B T}$
- ▶ Rate of electrons $SC \rightarrow M \propto \exp \frac{-e(V_0 - V)}{k_B T}$

Schottky diode: $I - V$ characteristics

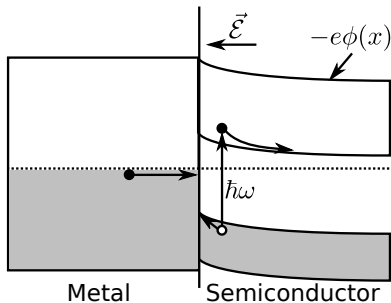
- ▶ Net current density $j = j_2 \exp \frac{-e(V_0 - V)}{k_B T} - j_1 \exp \frac{-\phi_B}{k_B T}$
- ▶ At equilibrium $V = 0$, $j = 0 \Rightarrow j_2 \exp \frac{-eV_0}{k_B T} = j_1 \exp \frac{-\phi_B}{k_B T} = j_0$ (say)
- ▶ Therefore:

$$j = j_0 \left(\exp \frac{eV}{k_B T} - 1 \right)$$

- ▶ Exponentially increasing current in forward bias ($V > 0$)
- ▶ Current saturates to $-j_0$ in reverse bias
- ▶ j_0 is given by Richardson-Dushman equation, just different B_e !

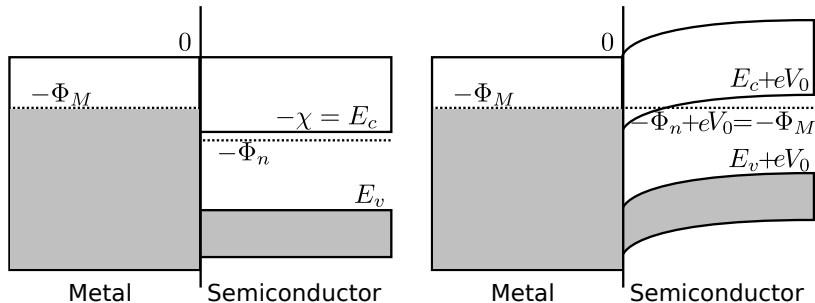


Schottky photovoltaic devices



- ▶ Contact potential \Rightarrow built-in field at interface
- ▶ Photon absorption $\rightarrow e$ - h pair, separated by field
- ▶ In n -type junction, e relaxes to band edge and driven into bulk SC
- ▶ h recombines at interface (met by e current in metal)
- ▶ Below band-gap, interfacial generation also possible

Ohmic contact



- ▶ Similar geometry to Schottky diode, but different level alignment
- ▶ Consider metal Fermi level lines up inside conduction band (or analogously for p -type material, inside valence band)
- ▶ Bands bend in opposite direction to equalize Fermi levels
- ▶ No barrier Φ_B any more, electrons free to flow
- ▶ $j(V)$ dominated by linear resistance of bulk semiconductor
- ▶ $I-V$ follows Ohm's law \Rightarrow Ohmic contact

Peltier effect in Ohmic contacts

- ▶ Electrons flowing to the left pick up energy $E_c - E_F$
- ▶ Electrons flowing to the right lose energy $E_c - E_F$
- ▶ Energy drawn/dissipated from/as thermal energy at junction
- ▶ Combine p and n -type junctions to get cooling in same metal
- ▶ Reverse operation: thermoelectric generator (heat to electricity)

